

TAIPEI
TAIWAN

MESA
2022

CALL FOR PAPER

The 18th IEEE/ASME International Conference
on Mechatronic and Embedded Systems and Applications

NOVEMBER
28>30
HYBRID
2022

OBJECTIVES

The goal of the 18th IEEE/ASME MESA 2022 is to bring together experts from the fields of mechatronics and embedded systems, disseminate the recent advances in the area, discuss future research directions, and exchange application experience. MESA 2022 will especially bring out and highlight the latest research results and developments in Industry 4.0 and Artificial Intelligence (AI) in the fields of mechatronics and embedded systems. MESA2022 will be hybrid.

SYMPOSIA

- MESA-1 Artificial Intelligence and Emerging Technologies for Mechatronics and Embedded Systems
- MESA-2 Bio-Inspired Robotics and Soft Robotics
- MESA-3 Robotics and Mobile Machines
- MESA-4 Mechatronic and Embedded Systems for Agriculture 4.0
- MESA-5 Disturbance Rejection Control
- MESA-6 Mechatronics and Embedded Systems Applications
- MESA-7 Embedded Systems Infrastructure and Theory
- MESA-8 Embedded Vision and Ambient Intelligence
- MESA-9 Mechatronics and Industry 4.0
- MESA-10 Smart Cyber-Physical Systems
- MESA-11 Sensors and Actuators
- MESA-12 Mechatronics and Embedded Systems Education
- MESA-13 Micro-/Nano-Manipulation Technologies and Applications
- MESA-14 Fractional Derivatives and Their Applications
- MESA-15 Unmanned Vehicle Technologies and Applications
- MESA-16 Bio-Mechatronics - Medical Devices & Technologies
- MESA-17 Mechatronics and Embedded Technologies in Intelligent Transportation Systems

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IMPORTANT DATES

Submission of full-length paper	16-Oct-2022
Author notification of acceptance	31-Oct-2022
Submission of copyright form	07-Nov-2022
Submission of final paper	07-Nov-2022

WEB-SITE

www.mesa2022.org

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PAPER SUBMISSION

Manuscripts should be at most six (6) pages in IEEE two-column format and must be submitted in PDF format via the conference web-site. Please use the LaTeX style file or Microsoft Word template to prepare your manuscript. Accepted, peer-reviewed papers will be published in the conference proceedings, EI indexed, and submitted to IEEE Xplore.